



ULTRA LOW NOISE, MEDIUM CURRENT

# E-PHEMT Transistor

## SAV-541+

50Ω 0.045-6GHz

### THE BIG DEAL

- Low Noise Figure, 0.5 dB
- Gain, 17 dB at 2 GHz
- High Output IP3, +33 dBm
- Output Power at 1dB comp., +20 dBm
- High Current, 60mA
- Wide bandwidth
- External biasing and matching required
- May be used as replacement <sup>a,b</sup> for Avago ATF-54143



Generic photo used for illustration purposes only

CASE STYLE: MMM1362

#### +RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

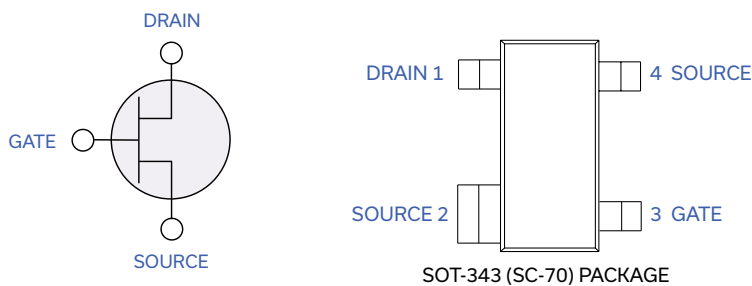
### APPLICATIONS

- Cellular
- ISM
- GSM
- WCDMA
- WiMax
- WLAN
- UNII and HIPERLAN

### PRODUCT OVERVIEW

SAV-541+ is an ultra-low noise, high IP3 transistor device, manufactured using E-PHEMT\* technology enabling it to work with a single positive supply voltage. It has outstanding Noise Figure, particularly below 2.5 GHz, and when combining this noise figure with high IP3 performance in a single device it makes it an ideal amplifier for demanding base station applications. We offer these units assembled into a complete module, 50Ω in/out, noise matched and fully specified. For more information please see our TAMP family of models on our web site.

### SIMPLIFIED SCHEMATIC AND PIN DESCRIPTION



Function	Pin Number	Description
Source	2 & 4	Source terminal, normally connected to ground
Gate	3	Gate used for RF Input
Drain	1	Drain used for RF output

\* Enhancement mode Pseudomorphic High Electron Mobility Transistor.

a. Suitability for model replacement within a particular system must be determined by and is solely the responsibility of the customer based on, among other things, electrical performance criteria, stimulus conditions, application, compatibility with other components and environmental conditions and stresses.

b. The Avago ATF-54143 part number is used for identification and comparison purposes only.

REV. F  
ECO-010314  
SAV-541+  
211022





ULTRA LOW NOISE, MEDIUM CURRENT

# E-PHEMT Transistor

SAV-541+

**ELECTRICAL SPECIFICATIONS AT  $T_{AMB}=25^{\circ}\text{C}$ , FREQUENCY 0.045 TO 6 GHz**

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
<b>DC Specifications</b>						
$V_{GS}$	Operational Gate Voltage	$V_{DS}=3\text{V}, I_{DS}=60\text{ mA}$	0.37	0.48	0.69	V
$V_{TH}$	Threshold Voltage	$V_{DS}=3\text{V}, I_{DS}=4\text{ mA}$	0.18	0.26	0.38	V
$I_{DSS}$	Saturated Drain Current	$V_{DS}=3\text{V}, V_{GS}=0\text{ V}$		1.0	5.0	$\mu\text{A}$
$G_M$	Transconductance	$V_{DS}=3\text{V}, G_m=\Delta I_{DS}/\Delta V_{GS}$ $\Delta V_{GS}=V_{GS1}-V_{GS2}$ $V_{GS1}=V_{GS}$ at $I_{DS}=60\text{ mA}$ $V_{GS2}=V_{GS1}+0.05\text{V}$	— — 230 — —	— — 392 — —	— — 560 — —	mS
$I_{GSS}$	Gate leakage Current	$V_{GD}=V_{GS}=-3\text{V}$			200	$\mu\text{A}$
<b>RF Specifications, <math>Z_0=50\text{ Ohms}</math> (Figure 1)</b>						
NF <sup>(1)</sup>	Noise Figure	$V_{DS}=3\text{V}, I_{DS}=60\text{ mA}$	f=0.9 GHz	0.4	—	dB
			f=2.0 GHz	0.5	0.9	
		$V_{DS}=4\text{V}, I_{DS}=60\text{ mA}$	f=3.9 GHz	1.0	—	
			f=5.8 GHz	1.9	—	
Gain	Gain	$V_{DS}=3\text{V}, I_{DS}=60\text{ mA}$	f=0.9 GHz	—	23.2	—
			f=2.0 GHz	15.0	17.6	18.5
		$V_{DS}=4\text{V}, I_{DS}=60\text{ mA}$	f=3.9 GHz	—	12.5	—
			f=5.8 GHz	—	8.7	—
OIP3	Output IP3	$V_{DS}=3\text{V}, I_{DS}=60\text{ mA}$	f=0.9 GHz	—	32.6	dBm
			f=2.0 GHz	30.0	33.1	
		$V_{DS}=4\text{V}, I_{DS}=60\text{ mA}$	f=3.9 GHz	—	33.0	
			f=5.8 GHz	—	31.0	
P1dB <sup>(2)</sup>	Power output at 1 dB Compression	$V_{DS}=3\text{V}, I_{DS}=60\text{ mA}$	f=0.9 GHz	—	19.1	dBm
			f=2.0 GHz	—	19.2	
		$V_{DS}=4\text{V}, I_{DS}=60\text{ mA}$	f=3.9 GHz	—	19.0	
			f=5.8 GHz	—	18.2	
		$V_{DS}=4\text{V}, I_{DS}=60\text{ mA}$	f=2.0 GHz	—	21.5	

**MAXIMUM RATINGS<sup>(3)</sup>**

Symbol	Parameter	Max.	Units
$V_{DS}$ <sup>(4)</sup>	Drain-Source Voltage	5	V
$V_{GS}$ <sup>(4)</sup>	Gate-Source Voltage	-5 to 0.7	V
$V_{GD}$ <sup>(4)</sup>	Gate-Drain Voltage	-5 to 0.7	V
$I_{DS}$ <sup>(4)</sup>	Drain Current	120	mA
$I_{GS}$	Gate Current	2	mA
$P_{DISS}$	Total Dissipated Power	360	mW
$P_{IN}$ <sup>(5)</sup>	RF Input Power	17	dBm
$T_{CH}$	Channel Temperature	150	$^{\circ}\text{C}$
$T_{OP}$	Operating Temperature	-40 to 85	$^{\circ}\text{C}$
$T_{STD}$	Storage Temperature	-65 to 150	$^{\circ}\text{C}$
$\theta_{JC}$	Thermal Resistance	160	$^{\circ}\text{C}/\text{W}$

(1) Includes test board loss (tested on Mini-Circuits TB-471+ test board)  
 (2) Drain current was allowed to increase during compression measurements.  
 (3) Operation of this device above any one of these parameters may cause permanent damage.  
 (4) Assumes DC quiescent conditions.  
 (5) IGS is limited to 2 mA during test.





### CHARACTERIZATION TEST CIRCUIT

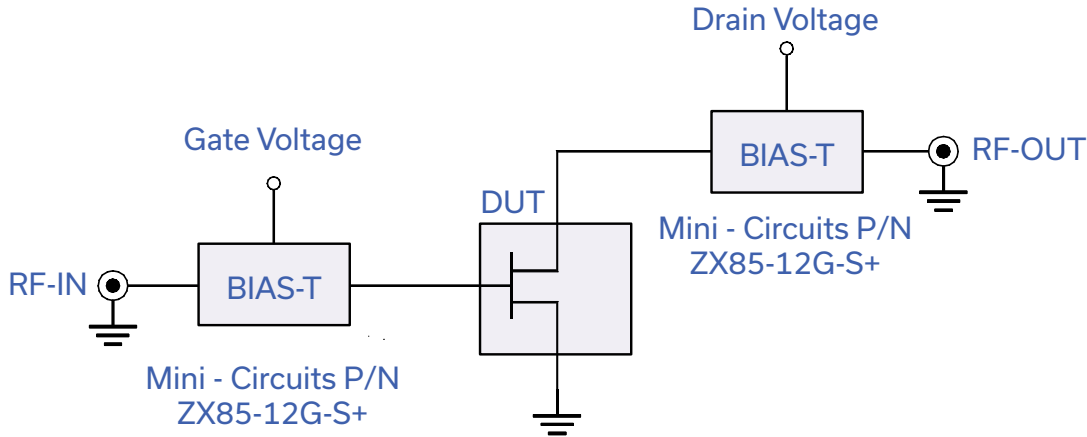


Fig 1. Block Diagram of Test Circuit used for characterization. (DUT soldered on Mini-Circuits Test Board TB-471+)

Gain, Output power at 1dB compression (P1 dB) and output IP3 (OIP3) are measured using R&S Network Analyzer ZVA-24. Noise Figure measured using Agilent Noise Figure meter N8975A and Noise Source N4000A.

Conditions:

1. Drain voltage (with reference to source, VDS)= 3 or 4V as shown.
2. Gate Voltage (with reference to source, VGS) is set to obtain desired Drain-Source current (IDS) as shown in graphs or specification table.
3. Gain: Pin= -25dBm
4. Output IP3 (OIP3): Two tones, spaced 1 MHz apart, 0 dBm/tone at output.
5. No external matching components used.

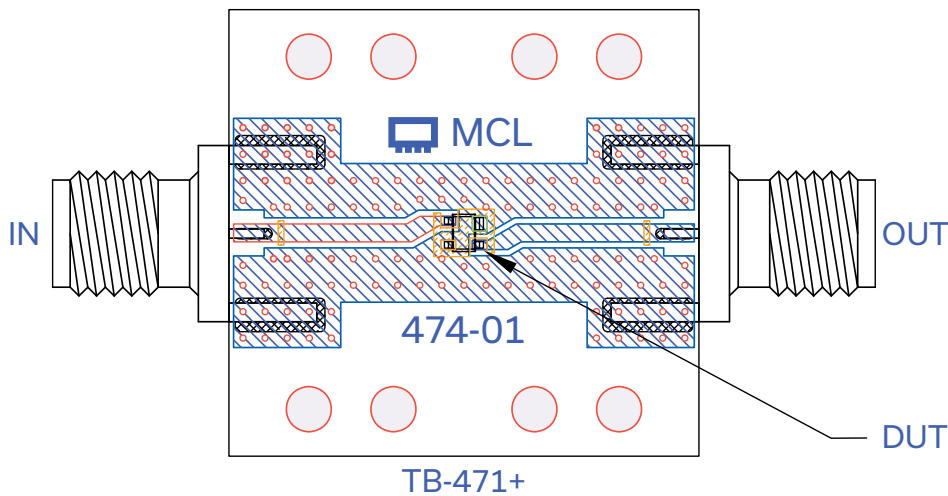
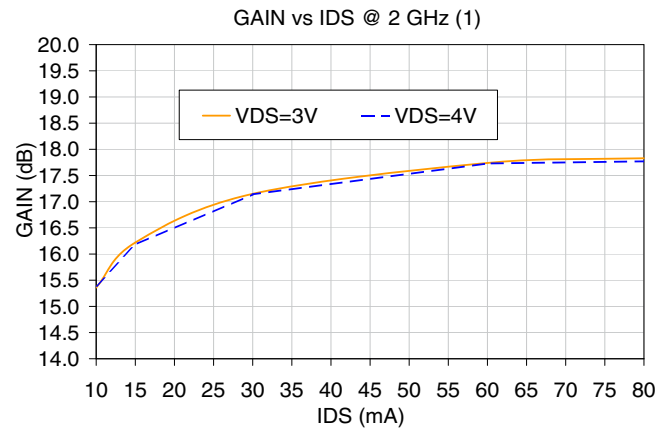
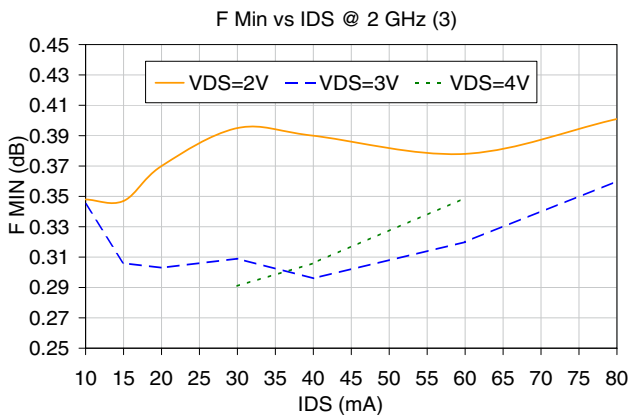
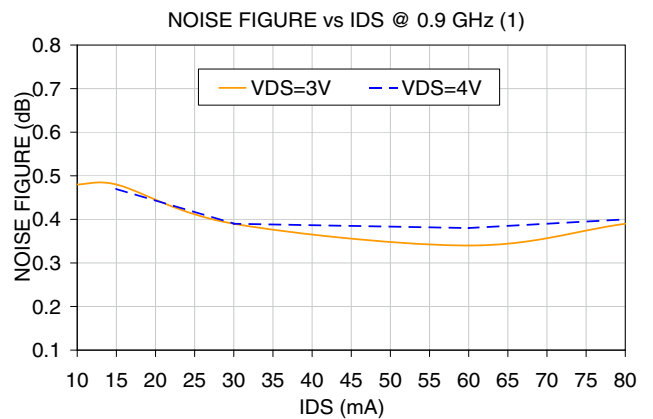
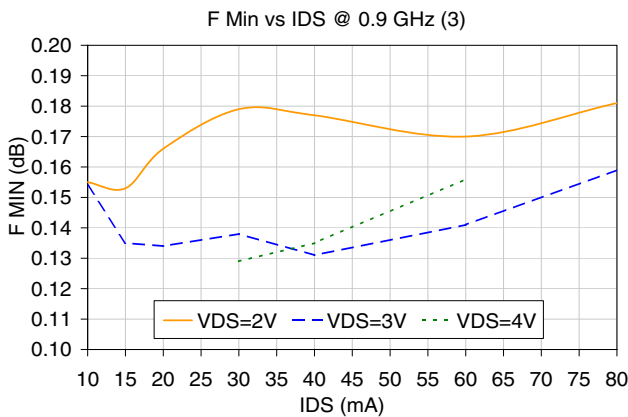
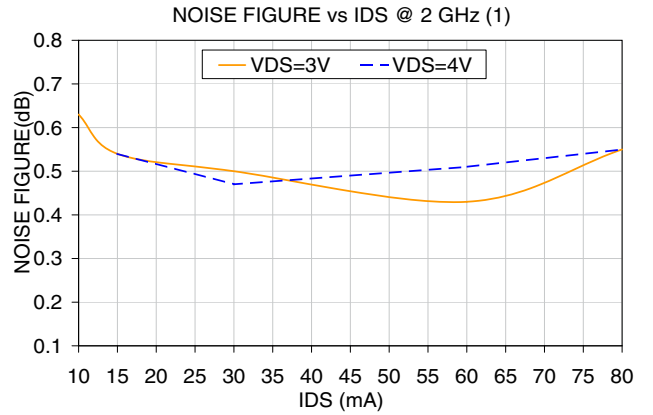
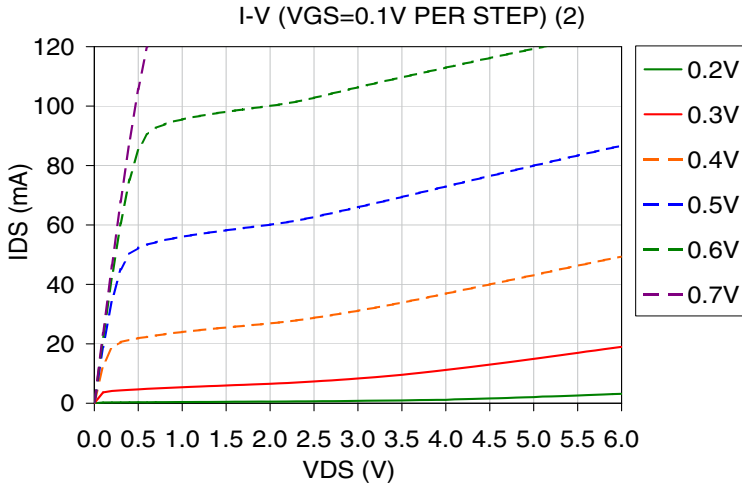


Fig 2. Test Board used for characterization, Mini-Circuits P/N TB-471+ (Material: Rogers 4350, Thickness: 0.02")



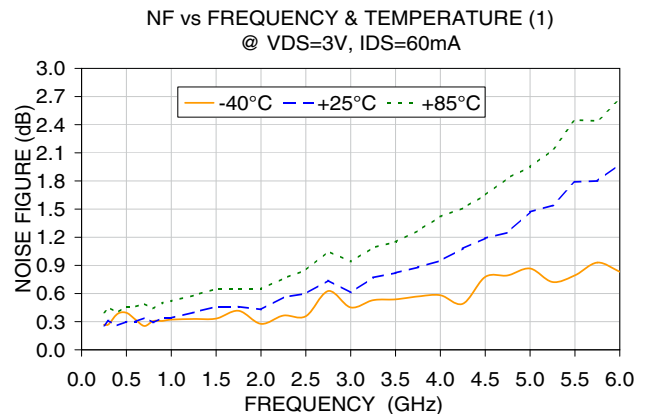
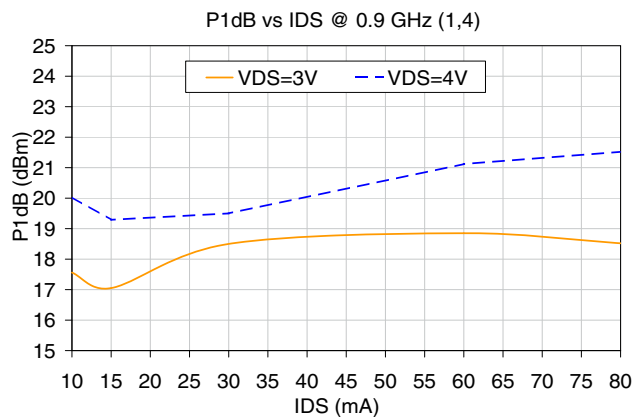
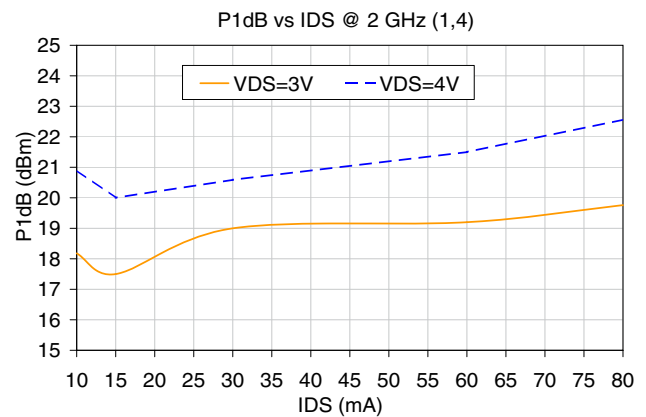
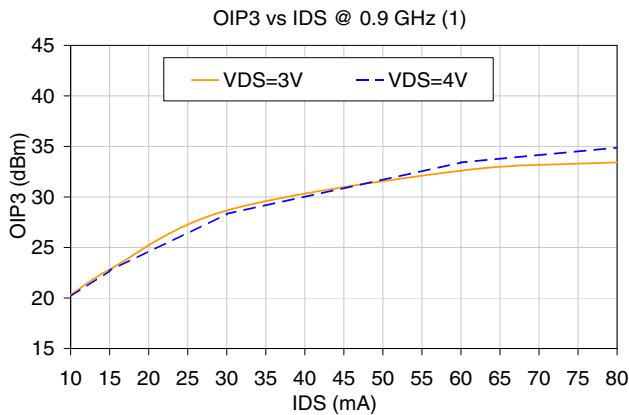
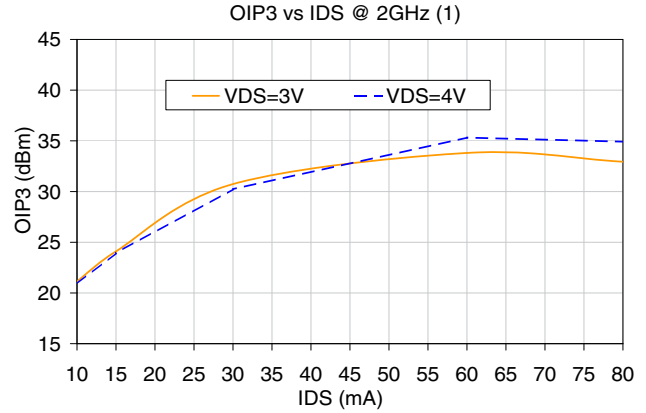
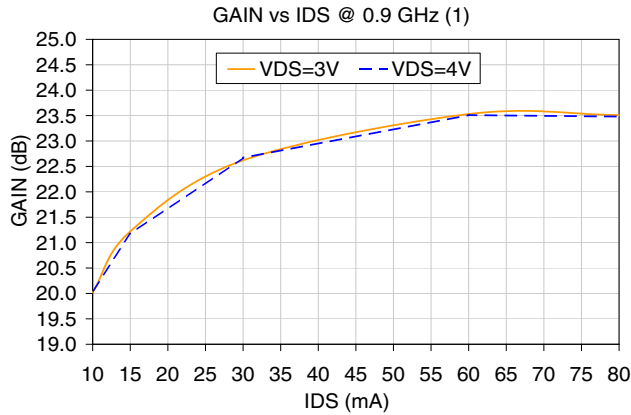
### TYPICAL PERFORMANCE CURVES



(1) Includes test board loss, set-up and conditions per Figure 1.  
 (2) Measured using HP4155B semiconductor parameter analyzer.  
 (3) F Min is minimum Noise Figure.  
 (4) Drain Current was allowed to increase during compression measurement.



### TYPICAL PERFORMANCE CURVES

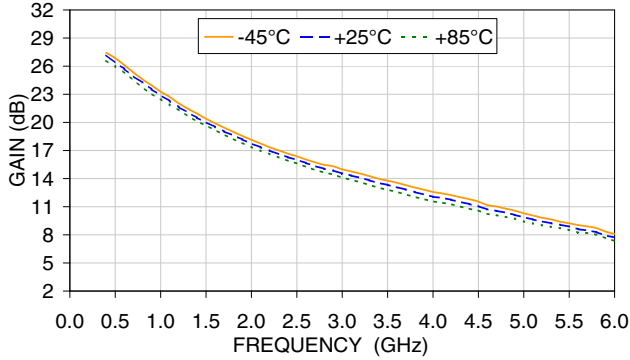


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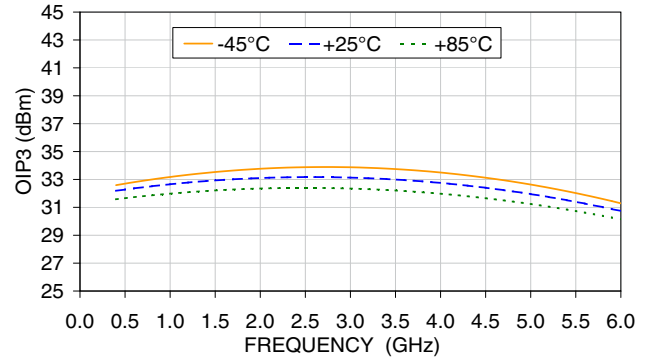


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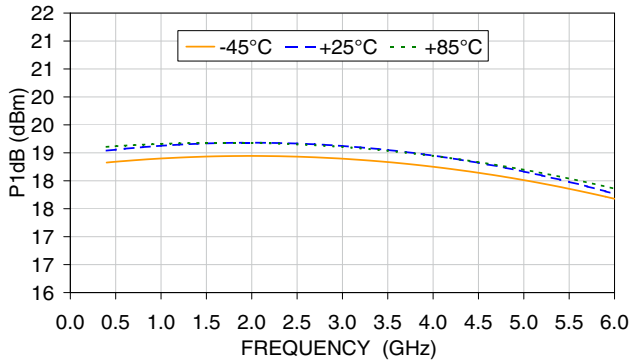
GAIN vs FREQUENCY & TEMPERATURE (1)  
@ VDS=3V, IDS=60mA



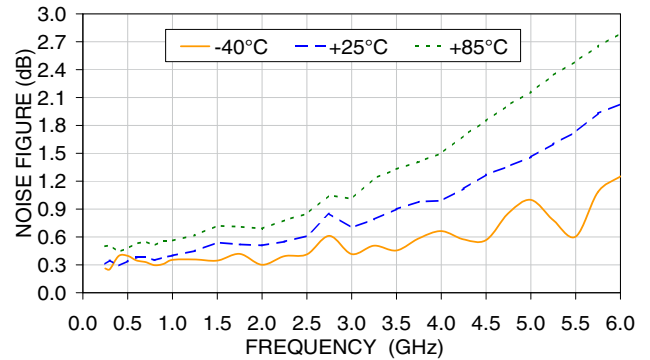
OIP3 vs FREQUENCY & TEMPERATURE (1)  
@ VDS=3V, IDS=60mA



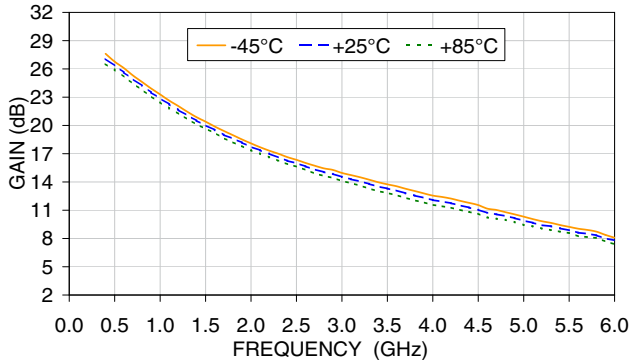
P1dB vs FREQUENCY & TEMPERATURE (1,4)  
@ VDS=3V, IDS=60mA



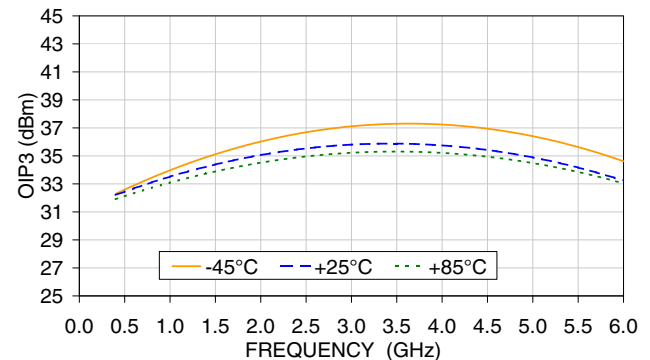
NF vs FREQUENCY & TEMPERATURE (1)  
@ VDS=4V, IDS=60mA



GAIN vs FREQUENCY & TEMPERATURE (1)  
@ VDS=4V, IDS=60mA



OIP3 vs FREQUENCY & TEMPERATURE (1)  
@ VDS=4V, IDS=60mA



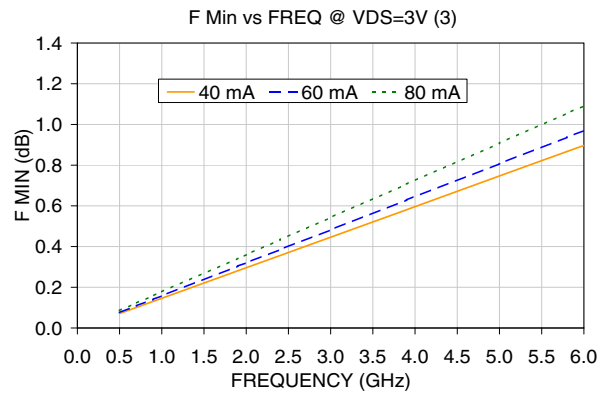
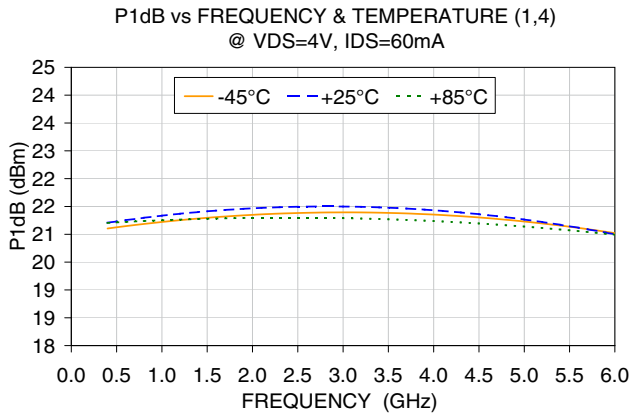
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## SAV-541+

### TYPICAL PERFORMANCE CURVES



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### REFERENCE PLANE LOCATION FOR S AND NOISE PARAMETERS

(see data in pages 8-11) (Refer to Application Note AN-60-040)

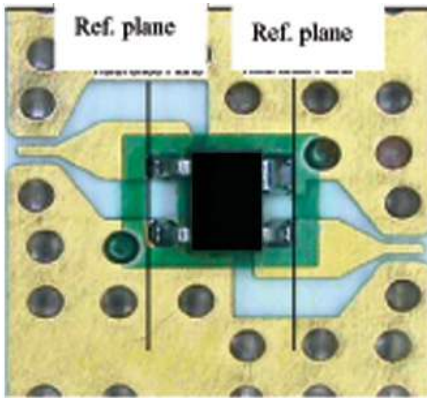


Fig 3. Reference Plane Location

Noise parameters were measured over 0.5 to 6 GHz by Modelithics® using a solid state tuner-based noise parameter (NP) test system available from Maury Microwave. F Min, optimum source reflection coefficient and noise resistance values are calculated values based on a set of measurements made at approximately 16 different impedances. Some data smoothing was applied to arrive at the presented data set.

S-parameters were measured by Modelithics® on an Anritsu Lightning vector network analyzer over 0.1 to 18GHz using 350um pitch RF probes from GGB industries combined with customized thru-reflect-line (TRL) calibration standards. The reference plane is at the device package leads, as shown in the picture.



ULTRA LOW NOISE, MEDIUM CURRENT

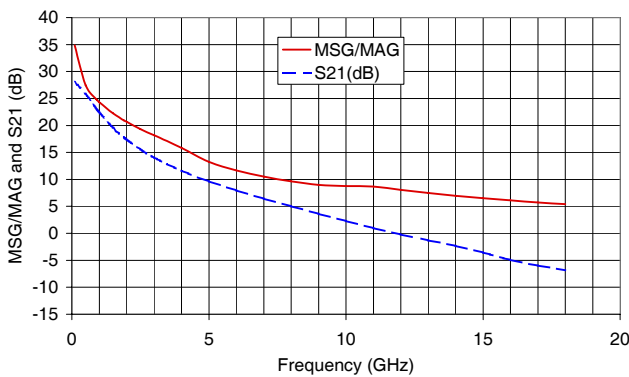
# E-PHEMT Transistor

SAV-541+

TYPICAL S-PARAMETERS,  $V_{DS}=3V$  AND  $I_{DS}=40\text{ MA}$  (FIG. 3)

Freq. (GHz)	S11		S21			S12		S22		MSG/MAG (dB)
	Mag.	Ang.	Mag.	Mag (dB)	Ang.	Mag.	Ang.	Mag.	Ang.	
0.1	0.99	-16.6	25.3	28.1	169.5	0.008	89.1	0.55	-14.7	34.8
0.5	0.86	-74.6	19.6	25.8	132.2	0.035	54.4	0.43	-55.3	27.5
0.9	0.75	-112.6	14.2	23.0	109.0	0.047	40.5	0.32	-83.3	24.8
1.0	0.74	-120.4	13.2	22.4	104.6	0.049	38.4	0.30	-89.5	24.3
1.5	0.68	-149.6	9.5	19.6	86.7	0.057	31.3	0.23	-114.1	22.3
1.9	0.66	-166.7	7.7	17.8	75.4	0.062	27.5	0.19	-131.2	21.0
2.0	0.66	-170.5	7.4	17.4	72.9	0.063	26.6	0.19	-135.2	20.7
2.5	0.65	172.8	6.0	15.6	61.0	0.07	22.9	0.17	-153.9	19.3
3.0	0.65	158.7	5.0	14.1	50.2	0.077	19.5	0.16	-171.3	18.2
4.0	0.66	134.4	3.8	11.6	30.0	0.091	11.9	0.16	156.7	15.8
5.0	0.68	113.5	3.0	9.7	11.1	0.104	2.7	0.18	130.5	13.3
6.0	0.71	94.7	2.5	8.0	-7.1	0.118	-7.5	0.22	109.1	11.7
7.0	0.75	77.8	2.1	6.4	-24.7	0.13	-18.3	0.28	90.7	10.5
8.0	0.78	62.4	1.8	5.0	-41.5	0.14	-29.4	0.33	74.8	9.6
9.0	0.82	47.8	1.5	3.6	-57.8	0.146	-41.0	0.40	60.0	9.0
10.0	0.85	33.7	1.3	2.3	-73.9	0.15	-52.7	0.46	46.1	8.8
11.0	0.88	20.6	1.1	1.0	-89.3	0.152	-64.4	0.53	33.2	8.7
12.0	0.90	8.4	1.0	-0.2	-104.0	0.153	-75.8	0.58	21.2	8.0
13.0	0.91	-3.5	0.9	-1.3	-118.3	0.154	-87.1	0.62	10.3	7.5
14.0	0.92	-14.4	0.8	-2.3	-131.9	0.154	-97.9	0.66	0.0	7.0
15.0	0.94	-23.0	0.7	-3.6	-143.0	0.148	-106.3	0.70	-8.7	6.5
16.0	0.95	-30.4	0.6	-4.9	-153.0	0.139	-114.2	0.75	-16.6	6.1
17.0	0.95	-39.0	0.5	-6.0	-164.0	0.134	-122.6	0.77	-25.2	5.7
18.0	0.94	-48.3	0.5	-6.9	-175.7	0.131	-131.4	0.79	-33.9	5.4

MAXIMUM STABLE GAIN (MSG)/MAXIMUM AVAILABLE GAIN (MAG) vs. FREQUENCY



Notes:  
 F Min.: Minimum Noise Figure  
 GOpt: Optimum Source Reflection Coefficient  
 Rn: Equivalent noise resistance

TYPICAL NOISE PARAMETERS,  $V_{DS}=3V$  AND  $I_{DS}=40\text{ MA}$  (FIG. 3)

Freq. (GHz)	F Min. (dB)	GOpt (Magnitude)	GOpt (Angle)	Rn/50	Ga Associated Gain (dB)
0.5	0.071	0.34	27.00	0.05	27.9
0.7	0.101	0.35	37.65	0.05	25.7
0.9	0.131	0.35	48.14	0.04	23.9
1.0	0.146	0.36	53.32	0.04	23.2
1.9	0.281	0.39	98.07	0.03	18.3
2.0	0.296	0.39	102.83	0.03	17.9
2.4	0.356	0.40	121.48	0.03	16.6
3.0	0.446	0.42	148.20	0.03	15.0
3.9	0.581	0.45	-174.52	0.05	13.4
5.0	0.747	0.48	-133.51	0.10	11.9
5.8	0.867	0.50	-106.84	0.14	10.9
6.0	0.897	0.50	-100.59	0.15	10.6







ULTRA LOW NOISE, MEDIUM CURRENT

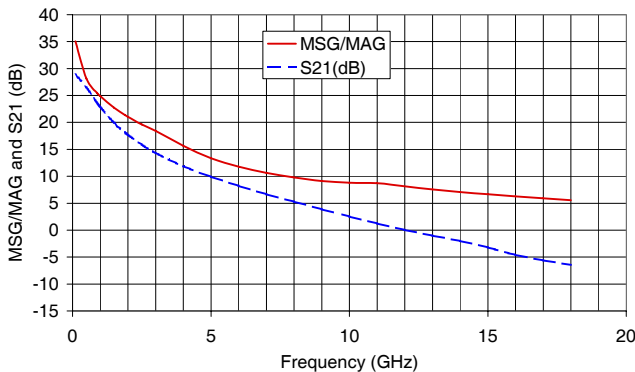
# E-PHEMT Transistor

SAV-541+

TYPICAL S-PARAMETERS, V<sub>DS</sub>=3V AND I<sub>DS</sub>=60 MA (FIG. 3)

Freq. (GHz)	S11		S21			S12		S22		MSG/MAG (dB)
	Mag.	Ang.	Mag.	Mag (dB)	Ang.	Mag.	Ang.	Mag.	Ang.	
0.1	0.99	-18.2	27.8	28.9	168.7	0.009	78.4	0.50	-14.8	35.0
0.5	0.85	-78.1	21.0	26.5	130.2	0.032	53.5	0.39	-60.2	28.1
0.9	0.74	-116.2	14.9	23.5	107.3	0.044	41.8	0.29	-90.1	25.3
1.0	0.72	-123.9	13.8	22.8	102.9	0.045	39.7	0.27	-96.8	24.9
1.5	0.67	-152.5	9.9	19.9	85.5	0.053	33.6	0.21	-122.9	22.7
1.9	0.65	-169.2	8.0	18.1	74.5	0.059	30.3	0.18	-140.6	21.4
2.0	0.65	-172.8	7.7	17.7	72.0	0.06	29.8	0.18	-144.8	21.0
2.5	0.65	170.9	6.2	15.9	60.5	0.068	26.6	0.17	-163.6	19.6
3.0	0.64	157.0	5.2	14.3	49.9	0.075	22.8	0.16	179.6	18.4
4.0	0.66	133.3	3.9	11.9	29.9	0.091	14.6	0.17	149.8	15.7
5.0	0.68	112.7	3.1	9.9	11.2	0.105	4.8	0.20	125.6	13.3
6.0	0.71	94.1	2.6	8.2	-6.8	0.12	-5.7	0.24	105.4	11.8
7.0	0.74	77.4	2.2	6.7	-24.1	0.132	-17.3	0.29	87.9	10.6
8.0	0.78	62.1	1.8	5.3	-40.8	0.142	-28.5	0.35	72.6	9.8
9.0	0.81	47.7	1.6	3.9	-56.9	0.149	-40.4	0.41	58.1	9.1
10.0	0.85	33.6	1.3	2.5	-72.8	0.152	-52.4	0.48	44.4	8.8
11.0	0.88	20.5	1.2	1.2	-88.0	0.154	-64.1	0.54	31.6	8.7
12.0	0.90	8.3	1.0	0.0	-102.6	0.154	-75.7	0.59	19.8	8.1
13.0	0.91	-3.5	0.9	-1.0	-116.9	0.155	-87.1	0.63	8.9	7.6
14.0	0.92	-14.4	0.8	-2.0	-130.4	0.155	-97.8	0.66	-1.3	7.1
15.0	0.93	-23.0	0.7	-3.2	-141.3	0.149	-106.3	0.71	-9.9	6.7
16.0	0.95	-30.5	0.6	-4.6	-151.3	0.14	-114.0	0.75	-17.6	6.3
17.0	0.95	-39.1	0.5	-5.6	-162.3	0.134	-122.4	0.77	-26.1	5.9
18.0	0.94	-48.4	0.5	-6.4	-174.0	0.132	-131.7	0.79	-34.7	5.6

MAXIMUM STABLE GAIN (MSG)/MAXIMUM AVAILABLE GAIN (MAG) vs. FREQUENCY



Notes:  
 F Min: Minimum Noise Figure  
 GOpt: Optimum Source Reflection Coefficient  
 Rn: Equivalent noise resistance

TYPICAL NOISE PARAMETERS, V<sub>DS</sub>=3V AND I<sub>DS</sub>=60 MA (FIG. 3)

Freq. (GHz)	F Min. (dB)	GOpt (Magnitude)	GOpt (Angle)	Rn/50	Ga Associated Gain (dB)
0.5	0.071	0.34	27.00	0.05	27.9
0.7	0.101	0.35	37.65	0.05	25.7
0.9	0.131	0.35	48.14	0.04	23.9
1.0	0.146	0.36	53.32	0.04	23.2
1.9	0.281	0.39	98.07	0.03	18.3
2.0	0.296	0.39	102.83	0.03	17.9
2.4	0.356	0.40	121.48	0.03	16.6
3.0	0.446	0.42	148.20	0.03	15.0
3.9	0.581	0.45	-174.52	0.05	13.4
5.0	0.747	0.48	-133.51	0.10	11.9
5.8	0.867	0.50	-106.84	0.14	10.9
6.0	0.897	0.50	-100.59	0.15	10.6





ULTRA LOW NOISE, MEDIUM CURRENT

# E-PHEMT Transistor

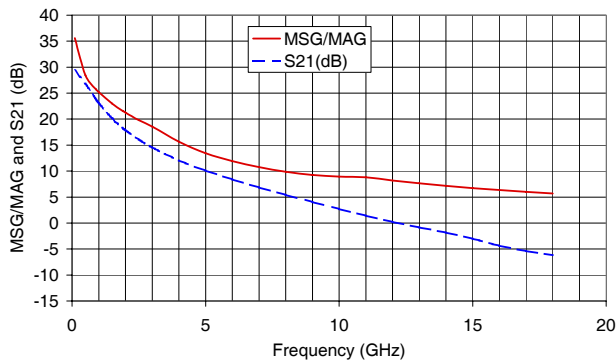
SAV-541+

Mini-Circuits

TYPICAL S-PARAMETERS,  $V_{DS}=3V$  AND  $I_{DS}=80\text{ MA}$  (FIG. 3)

Freq. (GHz)	S11		S21			S12		S22		MSG/MAG (dB)
	Mag.	Ang.	Mag.	Mag (dB)	Ang.	Mag.	Ang.	Mag.	Ang.	
0.1	0.99	-18.3	29.4	29.4	168.4	0.008	84.4	0.48	-16.4	35.6
0.5	0.84	-79.6	21.8	26.8	129.4	0.031	54.8	0.36	-62.3	28.4
0.9	0.73	-117.7	15.4	23.7	106.5	0.041	42.7	0.27	-93.1	25.7
1.0	0.71	-125.3	14.2	23.1	102.2	0.043	40.4	0.25	-99.8	25.2
1.5	0.66	-153.7	10.2	20.2	85.0	0.051	35.2	0.20	-126.4	23.0
1.9	0.65	-170.2	8.2	18.3	74.1	0.057	32.5	0.18	-144.2	21.6
2.0	0.65	-173.8	7.8	17.9	71.7	0.059	31.6	0.18	-148.3	21.3
2.5	0.64	170.2	6.3	16.1	60.2	0.066	28.2	0.16	-167.0	19.8
3.0	0.64	156.4	5.3	14.5	49.8	0.074	24.7	0.16	176.5	18.6
4.0	0.65	132.9	4.0	12.1	30.0	0.09	16.1	0.17	147.5	15.7
5.0	0.67	112.4	3.2	10.1	11.4	0.106	6.1	0.20	124.0	13.4
6.0	0.70	94.0	2.6	8.4	-6.5	0.12	-5.0	0.24	104.4	11.9
7.0	0.74	77.4	2.2	6.9	-23.8	0.133	-16.3	0.29	87.2	10.8
8.0	0.77	62.1	1.9	5.4	-40.4	0.142	-27.9	0.35	71.9	9.9
9.0	0.81	47.7	1.6	4.0	-56.4	0.15	-39.9	0.42	57.5	9.3
10.0	0.85	33.6	1.4	2.7	-72.3	0.153	-52.0	0.48	43.8	8.9
11.0	0.87	20.5	1.2	1.4	-87.4	0.155	-63.9	0.54	31.2	8.8
12.0	0.90	8.3	1.0	0.2	-102.0	0.155	-75.4	0.59	19.4	8.2
13.0	0.91	-3.5	0.9	-0.8	-116.2	0.156	-86.8	0.63	8.6	7.6
14.0	0.92	-14.4	0.8	-1.8	-129.6	0.156	-97.7	0.66	-1.6	7.2
15.0	0.93	-23.0	0.7	-3.0	-140.7	0.15	-106.2	0.71	-10.2	6.7
16.0	0.95	-30.5	0.6	-4.4	-150.6	0.14	-113.9	0.75	-17.9	6.4
17.0	0.95	-39.1	0.5	-5.4	-161.5	0.135	-122.3	0.77	-26.4	6.0
18.0	0.94	-48.5	0.5	-6.2	-173.4	0.133	-131.2	0.78	-35.0	5.7

MAXIMUM STABLE GAIN (MSG)/MAXIMUM AVAILABLE GAIN (MAG) vs. FREQUENCY



TYPICAL NOISE PARAMETERS,  $V_{DS}=3V$  AND  $I_{DS}=80\text{ MA}$  (FIG. 3)

Freq. (GHz)	F Min. (dB)	GOpt (Magnitude)	GOpt (Angle)	Rn/50	Ga Associated Gain (dB)
0.5	0.086	0.31	27.68	0.05	28.4
0.7	0.123	0.31	39.97	0.05	26.3
0.9	0.159	0.32	51.98	0.04	24.6
1.0	0.178	0.32	57.88	0.04	23.8
1.9	0.342	0.35	107.88	0.03	19.1
2.0	0.360	0.35	113.08	0.03	18.7
2.4	0.433	0.36	133.22	0.03	17.4
3.0	0.543	0.39	161.34	0.04	15.9
3.9	0.707	0.43	-161.16	0.07	14.1
5.0	0.908	0.49	-122.96	0.13	12.5
5.8	1.055	0.54	-100.45	0.20	11.4
6.0	1.091	0.56	-95.52	0.22	11.2

Notes:  
 F Min: Minimum Noise Figure  
 GOpt: Optimum Source Reflection Coefficient  
 Rn: Equivalent noise resistance





ULTRA LOW NOISE, MEDIUM CURRENT

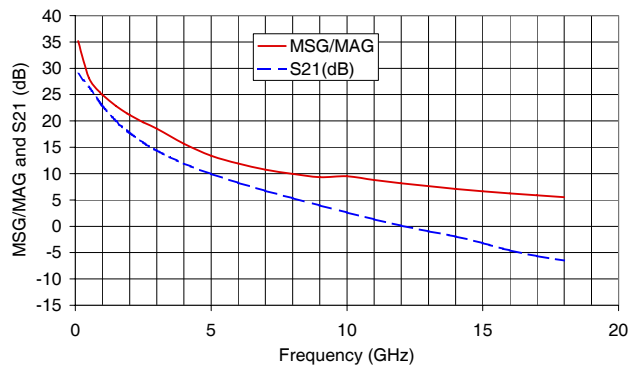
# E-PHEMT Transistor

SAV-541+

TYPICAL S-PARAMETERS, V<sub>DS</sub>=4V AND I<sub>DS</sub>=60 MA (FIG. 3)

Freq. (GHz)	S11		S21			S12		S22		MSG/MAG (dB)
	Mag.	Ang.	Mag.	Mag (dB)	Ang.	Mag.	Ang.	Mag.	Ang.	
0.1	0.99	-17.9	27.9	28.9	168.5	0.008	83.7	0.53	-14.7	35.2
0.5	0.85	-77.9	21.0	26.5	130.2	0.032	54.0	0.40	-57.1	28.2
0.9	0.74	-116.0	15.0	23.5	107.3	0.043	41.4	0.29	-84.8	25.5
1.0	0.72	-123.7	13.9	22.8	102.9	0.044	39.3	0.27	-90.9	25.0
1.5	0.67	-152.3	10.0	20.0	85.5	0.052	33.5	0.21	-115.1	22.8
1.9	0.65	-169.0	8.1	18.1	74.5	0.058	30.2	0.18	-131.8	21.5
2.0	0.65	-172.6	7.7	17.7	72.0	0.059	29.6	0.17	-135.9	21.1
2.5	0.64	171.1	6.2	15.9	60.4	0.066	26.5	0.15	-154.5	19.7
3.0	0.64	157.3	5.2	14.4	49.8	0.073	22.9	0.14	-171.8	18.5
4.0	0.66	133.5	3.9	11.9	29.9	0.088	15.0	0.15	156.0	15.7
5.0	0.68	112.9	3.1	10.0	11.1	0.103	5.6	0.17	129.9	13.4
6.0	0.71	94.4	2.6	8.3	-6.9	0.117	-4.9	0.21	108.6	11.9
7.0	0.74	77.7	2.2	6.8	-24.3	0.13	-16.2	0.26	90.7	10.8
8.0	0.78	62.3	1.9	5.3	-41.1	0.14	-27.3	0.32	74.9	9.9
9.0	0.81	47.9	1.6	4.0	-57.4	0.147	-39.2	0.39	60.2	9.3
10.0	0.85	33.8	1.4	2.6	-73.5	0.151	-51.1	0.46	46.3	9.5
11.0	0.88	20.6	1.2	1.3	-88.9	0.154	-62.9	0.52	33.4	8.8
12.0	0.90	8.5	1.0	0.1	-103.6	0.154	-74.4	0.57	21.5	8.2
13.0	0.91	-3.4	0.9	-1.0	-118.0	0.156	-85.9	0.61	10.6	7.6
14.0	0.92	-14.3	0.8	-2.0	-131.6	0.156	-96.8	0.65	0.3	7.1
15.0	0.94	-22.9	0.7	-3.2	-142.8	0.149	-105.4	0.70	-8.5	6.7
16.0	0.95	-30.4	0.6	-4.6	-152.9	0.14	-113.3	0.74	-16.4	6.3
17.0	0.95	-39.0	0.5	-5.6	-164.0	0.135	-121.7	0.77	-25.0	5.9
18.0	0.95	-48.3	0.5	-6.5	-175.7	0.133	-131.0	0.78	-33.7	5.5

MAXIMUM STABLE GAIN (MSG)/MAXIMUM AVAILABLE GAIN (MAG) vs. FREQUENCY



Notes:  
 F Min: Minimum Noise Figure  
 GOpt: Optimum Source Reflection Coefficient  
 Rn: Equivalent noise resistance

TYPICAL NOISE PARAMETERS, V<sub>DS</sub>=4V AND I<sub>DS</sub>=60 MA (FIG. 3)

Freq. (GHz)	F Min. (dB)	GOpt (Magnitude)	GOpt (Angle)	Rn/50	Ga Associated Gain (dB)
0.5	0.086	0.34	26.43	0.06	28.1
0.7	0.121	0.34	37.91	0.05	26.0
0.9	0.156	0.34	49.17	0.05	24.2
1.0	0.173	0.34	54.72	0.04	23.4
1.9	0.331	0.35	102.19	0.03	18.7
2.0	0.349	0.35	107.19	0.03	18.3
2.4	0.419	0.36	126.64	0.03	17.0
3.0	0.524	0.37	154.19	0.04	15.4
3.9	0.682	0.41	-168.19	0.06	13.7
5.0	0.875	0.47	-128.23	0.12	12.2
5.8	1.016	0.52	-103.33	0.17	11.2
6.0	1.051	0.54	-97.65	0.18	11.0



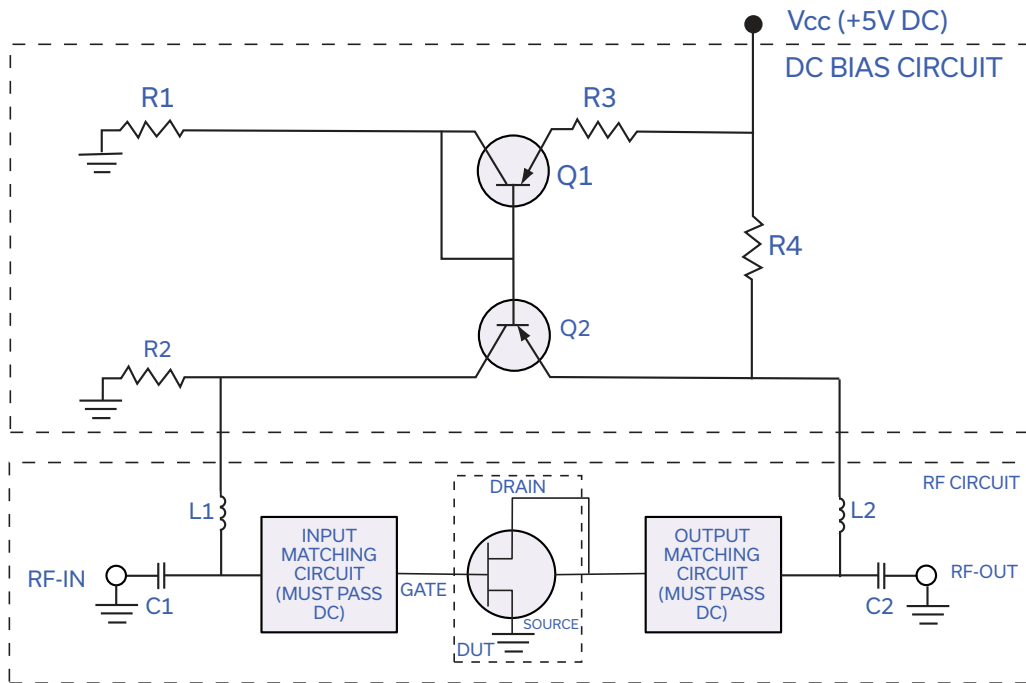


ULTRA LOW NOISE, MEDIUM CURRENT

# E-PHEMT Transistor

## SAV-541+

### RECOMMENDED APPLICATION CIRCUIT



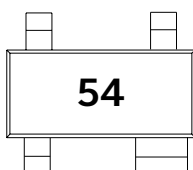
VDS, V (nom)	3	4
IDS, mA (nom)	60mA	60mA
R1	4320Ω	4320Ω
R2	4320Ω	4320Ω
R3	3570Ω	1210Ω
R4	33.2Ω	16.7Ω
Q1	MMBT3906*	MMBT3906*
Q2	MMBT3906*	MMBT3906*
C1	0.01μF	0.01μF
C2	0.01μF	0.01μF
L1**	840nH	840nH
L2**	840nH	840nH

\*Fairchild Semiconductor™ part number  
 \*\*Piconics™ part number CC45T47K240G5

### OPTIMIZED AMPLIFIER CIRCUITS

For band specific, drop-in modules, and as an alternative to designing circuits, please refer to Mini-Circuits TAMP and RAMP series models which are based upon SAV/TAV E-PHEMT's and include all DC blocking, bias, matching and stabilization circuitry, without need for any external components.

### PRODUCT MARKING





ADDITIONAL DETAILED TECHNICAL INFORMATION IS AVAILABLE ON OUR DASH BOARD. TO ACCESS [CLICK HERE](#)

Performance Data	Data Table
	Swept Graphs
	Performance data, graphs, s-parameter data set (.zip file)
Case Style	MMM1362 Plastic molded SOT-343 (SC-70) style package, lead finish: matte tin
Tape & Reel Standard quantities available on reel	F90 Standard quantities available on reel: 7" reels with 20, 50, 100, 200, 500, 1K, 2K, or 3K devices.
Suggested Layout for PCB Design	PL-300
Evaluation Board	TB-471+
Environmental Ratings	ENV08T2

### ESD RATING

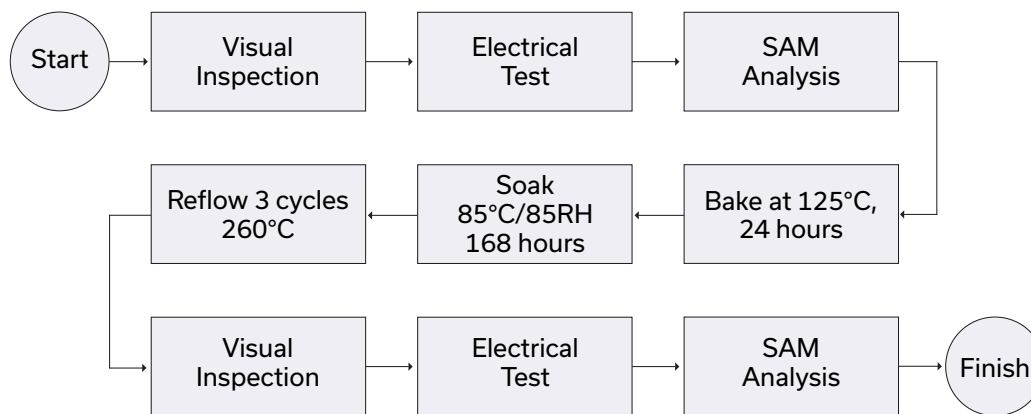
Human Body Model (HBM): Class 1A (250 V to < 500 V) in accordance with ANSI/ESD STM 5.1 - 2001

Machine Model (MM): Class M1 (40 V) in accordance with ANSI/ESD STM 5.2 - 1999

### MSL RATING

Moisture Sensitivity: MSL1 in accordance with IPC/JEDECJ-STD-020D

### MSL TEST FLOW CHART



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
  - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
  - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at [www.minicircuits.com/MCLStore/terms.jsp](http://www.minicircuits.com/MCLStore/terms.jsp)